

APPROVAL SHEET

WW06Y

±1% , ±5%

Metal Foil Power Low Ohm Chip Resistor

Wide Termination

RoHS Compliant and Halogen free

Size 0306 4xTerminals

*Contents in this sheet are subject to change without prior notice.

FEATURE

1. High power rating and compact size
2. High reliability and stability
3. Reduced size of final equipment
4. RoHS compliant and Halogen free products

APPLICATION

- Power supply
- PDA
- Digital meter
- Computer
- Automotives
- Battery charger
- DC-DC power converter

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added at longer sides. For ease of soldering the outer layer of these end terminations is Tin (lead free) alloy.

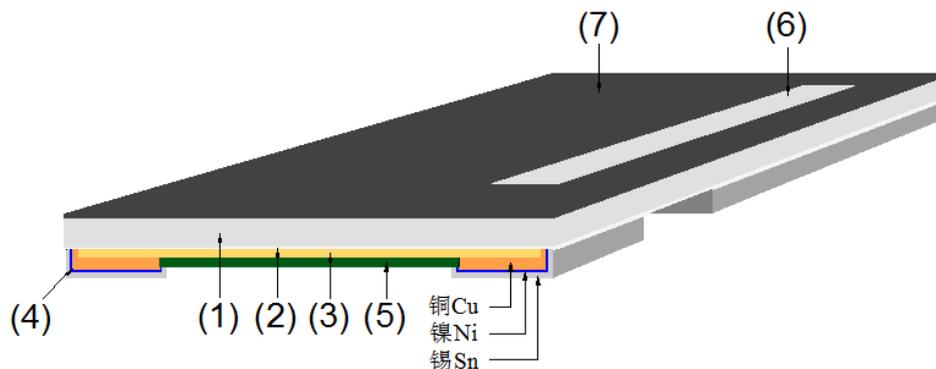


Fig 2. Construction of Chip-R

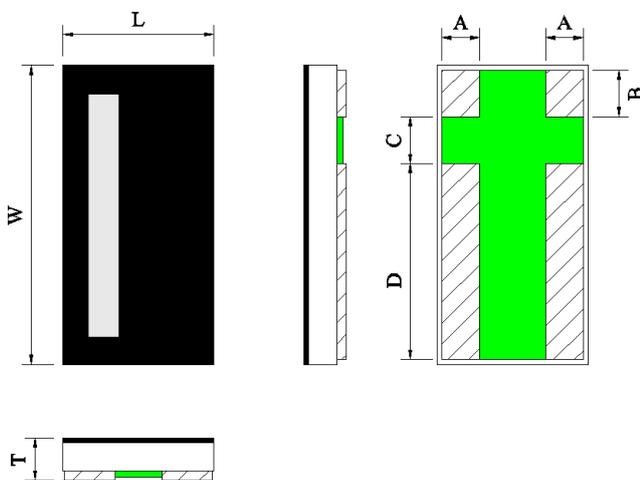
- (1) 基板 / Substrate : 氧化鋁陶瓷基板 / Alumina Ceramic
- (2) 粘著層 / Adhesion layer : 環氧樹脂 / Epoxy
- (3) 電阻本體 / Resistive element : 銅合金 / Cu alloy
- (4) 端電極 / Terminal electrode : 錫, 鎳, 銅 / Sn, Ni, Cu without side electrode**
- (5) 保護層 / Protective coating : 防火級環氧樹脂,符合UL- 94-V0 要求(綠色) / Flame-retardant epoxy, meets UL-94-V0 requirements(green)
- (6) 字碼 / Marking coating(6) : 防火級環氧樹脂,符合UL- 94-V0 要求(白色) / Flame-retardant epoxy, meets UL-94-V0 requirements (white)
- (7) 文印防焊層 / Marking coating(7) : 防火級環氧樹脂,符合UL- 94-V0 要求(黑色) / Flame-retardant epoxy, meets UL-94-V0 requirements (black)

QUICK REFERENCE DATA

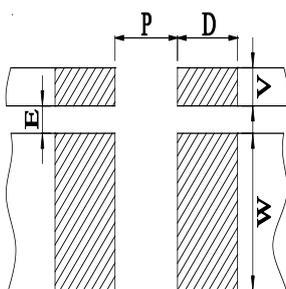
Item	General Specification
Series No.	WW06Y
Size code	0306 (0816)
Resistance Tolerance	±1%, ±5%
Resistance Range	1mΩ ~ 10mΩ
TCR (ppm/°C) : 25 ~ 125°C	
1 ~ 4mΩ	±100 ppm/°C
5 ~ 10mΩ	±50 ppm/°C
Max. dissipation at T _{amb} =70°C	0.5W
Max current	9A
Operation temperature	-55 ~ +155°C

MECHANICAL DATA (unit : mm)

WW06Y	W	L	A	B	C	D	T
	1.60±0.20	0.80±0.15	0.18±0.10	0.23±0.10	0.40±0.10	0.93±0.20	0.55±0.10



LAND PATTERN (unit: mm)



unit: mm

WW06Y	P	W	D	V	E
	0.35	1.30	0.40	0.40	0.20

MARKING

No marking.

FUNCTIONAL DESCRIPTION

Derating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.3

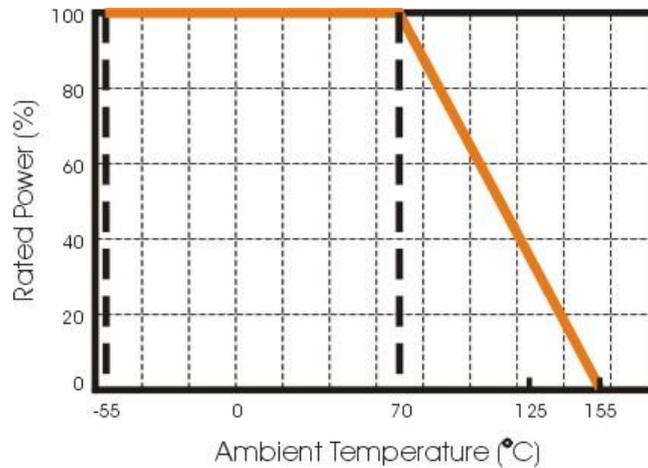


Figure 3. Maximum dissipation in percentage of rated power as a function of the ambient temperature.

MOUNTING

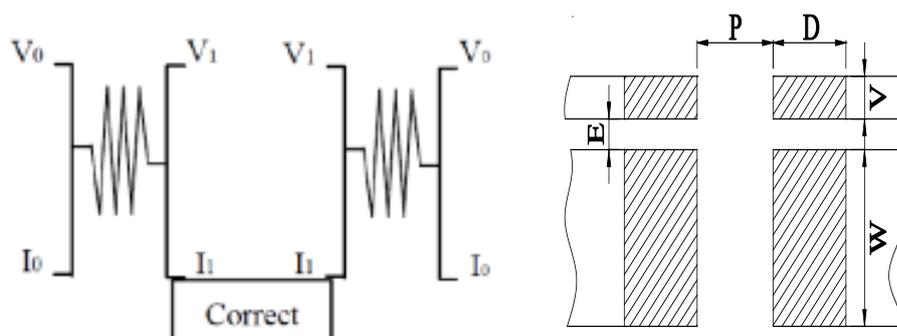
Due to metal foil design, WW12Y is **up-side-down mounting** by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

CIRCUIT DIAGRAM



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 4.

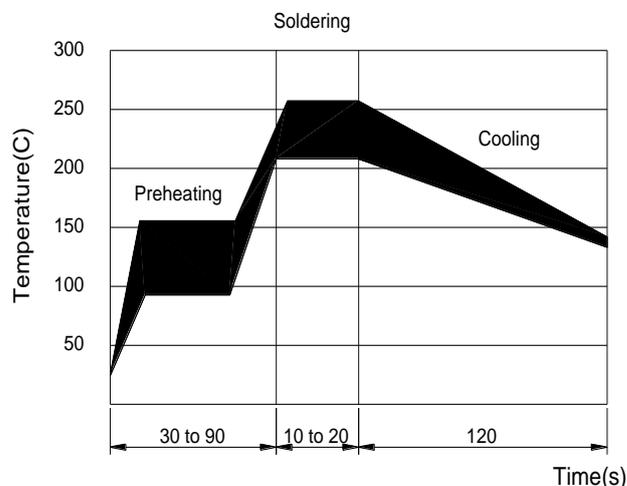


Fig 4. Infrared soldering profile for Chip Resistors

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WW06	Y	R001	F	T	L
Size code WW06 : 0306	Type code Y : Metal Foil 4T	Resistance code 3 significant digits followed by no. of zeros 0.001Ω = R001	Tolerance F : ±1% J : ±5%	Packaging code T : 7" Reel PC tape	Termination code L = Sn base (lead free)

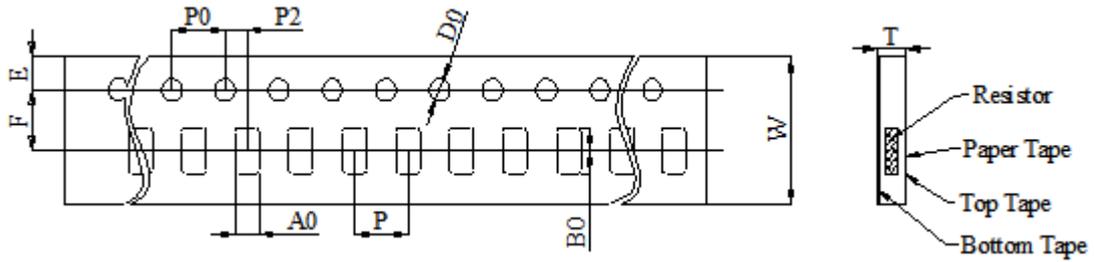
WW06Y taping qty: plastic tape 5,000pcs per 7" reel

TEST AND REQUIREMENTS (IEC60115)

測試方法 Parameter	條件 Conditions	允收標準 Requirements
瞬間過載測試 / Short Time Over Load	P= 2.5Pr ; T=25±2°C , t = 5sec.	ΔR/R max ±1.0% IEC60115-1 4.13
高溫測試 / High Temp. Exposure	T = +155±2°C ; t = 1000h	ΔR/R max ±1.0% IEC60115-1 4.25
低溫測試 / Low Temp. Storage	T = -55±2°C ; t = 1000h	ΔR/R max ±1.0% IEC60115-1 4.25
濕度負載壽命測試 / Moisture Load Life (60°C、95%RH)	Vtest = Vmax ; T=60±2°C ; RH=95% ; t= 90min ON , 30min OFF , 1000h	ΔR/R max ±2.0% IEC60115-1 4.25
冷熱衝擊測試 / Thermal Shock	[-55°C 30min. → R.T. 3min. → +155°C 30min. → R.T. 3min], 100 個連續循環 / 100Cycles	ΔR/R max ±1.0% IEC60115-1 4.19
在 70°C 下負載壽命測試 / Load Life at 70°C	Vtest = Vmax ; T=70±2°C ;t= 90min ON , 30min OFF,1000h	ΔR/R max ±2.0% IEC60115-1 4.25
可焊性測試 / Solderability	浸入錫爐 / Dip into solder at T = 245±5°C , t = 3±0.5sec.	錫涵蓋面積 /The covered area >95% IEC60115-1 4.17
抗焊熱性測試 / Resistance to Solder Heat	經熱風式迴焊爐 / Through Reflow 3 cycles	ΔR/R max ±1.0% IEC60115-1 4.18
機械衝擊測試 / Mechanical Shock	加速度 a =100G , 振幅時間 t =6ms, a =100G , t =11ms,	ΔR/R max ±1.0% IEC60115-1 4.21
基板彎曲測試 / Substrate Bending	兩支撐點間距 / Span between fulcrums : 90mm ; 振幅 / Bend Width : 2mm ; t=60sec 測試板/Test board : 玻璃纖維板/ Glass-Epoxy Board ;厚度 / Thickness =1.6mm	ΔR/R max ±1.0% IEC60115-1 4.33

PACKAGING

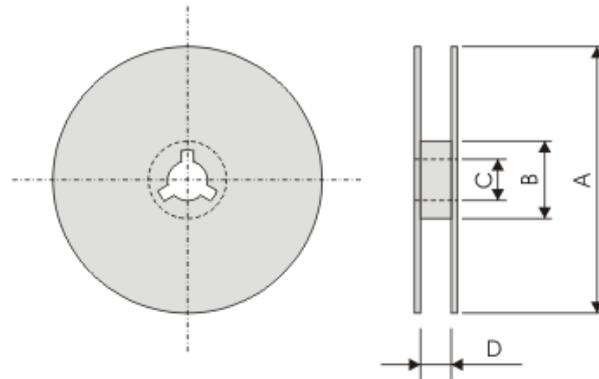
Plastic Tape specifications (unit :mm)



Type	Ao	Bo	W	F	E
WW06Y	0.98±0.20	1.85±0.20	8.00±0.30	3.50±0.10	1.75±0.10

Type	P	P0	ΦD	T
WW06Y	4.00±0.10	4.00±0.10	Φ1.50 ^{+0.1} _{-0.0}	0.75±0.20

Reel dimensions



(unit : mm)

Symbol	A	B	C	D
7" Reel	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±1.00

Taping quantity

WW06Y by paper tape taping 5,000 pcs per reel!